

## AM20P03-60D-T1-PF-VB Datasheet P-Channel 30-V (D-S) MOSFET

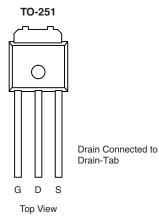
PRODUCT SUMMARY						
V <sub>DS</sub> (V)	R <sub>DS(on)</sub> (Ω)	I <sub>D</sub> (A) <sup>d</sup>	Q <sub>g</sub> (Typ.)			
- 30	0.056at V <sub>GS</sub> = - 10 V	- 20	19 nC			
- 30	0.072 at V <sub>GS</sub> = - 4.5 V	- 15	19110			

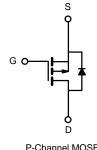


- Halogen-free
- TrenchFET<sup>®</sup> Power MOSFET
- 100 % R<sub>g</sub> Tested
- 100 % UIS Tested

#### **APPLICATIONS**

- Load Switch
- Notebook Adaptor Switch





<b>ABSOLUTE MAXIMUM RATINGS</b> T	$A = 25 \ ^{\circ}C$ , unless othe	erwise noted		
Parameter	Symbol	Limit	Unit	
Drain-Source Voltage	V <sub>DS</sub>	- 30	V	
Gate-Source Voltage	V <sub>GS</sub>	± 20	v	
	T <sub>C</sub> = 25 °C		- 20	
Continuous Drain Current ( $T_1 = 150 \text{ °C}$ )	T <sub>C</sub> = 70 °C		- 15	
Continuous Drain Current $(T_j = 150^{\circ} C)$	T <sub>A</sub> = 25 °C	I <sub>D</sub>	-7.9 <sup>a, b</sup>	
	T <sub>A</sub> = 70 °C		- 5.6 <sup>a, b</sup>	•
Pulsed Drain Current	I <sub>DM</sub>	- 60	Α	
October Decis Dista October	T <sub>C</sub> = 25 °C		- 20	
Continuous Source-Drain Diode Current	T <sub>A</sub> = 25 °C	I <sub>S</sub>	- 7.9 <sup>a, b</sup>	
Avalanche Current	L = 0.1 mH	I <sub>AS</sub>	- 20	
Single-Pulse Avalanche Energy	L = 0.1 IIIH	E <sub>AS</sub>	20	mJ
	T <sub>C</sub> = 25 °C		20	
Movimum Dower Dissinction	T <sub>C</sub> = 70 °C	P <sub>D</sub>	15	W
Maximum Power Dissipation	T <sub>A</sub> = 25 °C	ГD	2.7 <sup>a, b</sup>	vv
	T <sub>A</sub> = 70 °C	1	1.7 <sup>a, b</sup>	
Operating Junction and Storage Temperature Range	T <sub>J</sub> , T <sub>stg</sub>	- 55 to 150	°C	

THERMAL RESISTANCE RATINGS						
Parameter		Symbol	Typical	Maximum	Unit	
Maximum Junction-to-Ambient <sup>a, c</sup>	t ≤ 10 s	R <sub>thJA</sub>	38	46	°C/W	
Maximum Junction-to-Foot	Steady State	R <sub>thJF</sub>	20	25	0/10	

Notes:

b. t = 10 s.

c. Maximum under Steady State conditions is 85 °C/W.

d. Based on T<sub>C</sub> = 25 °C.

a. Surface mounted on 1" x 1" FR4 board.

<b>SPECIFICATIONS</b> $T_J = 25 \circ C$	C, unless oth	erwise noted				
Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit
Static						
Drain-Source Breakdown Voltage	V <sub>DS</sub>	V <sub>GS</sub> = 0 V, I <sub>D</sub> = - 250 μA	- 30			V
V <sub>DS</sub> Temperature Coefficient	$\Delta V_{DS}/T_{J}$	I <sub>D</sub> = - 250 μA		- 34		mV/
V <sub>GS(th)</sub> Temperature Coefficient	$\Delta V_{GS(th)}/T_J$	i <sub>D</sub> = - 250 μA		5.3		°C
Gate-Source Threshold Voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}, I_{D} = -250 \ \mu A$	- 1.4		- 2.5	V
Gate-Source Leakage	I <sub>GSS</sub>	$V_{DS} = 0 V, V_{GS} = \pm 25 V$			± 100	nA
Zana Olata Malla na Dira'a Olama di		$V_{DS} = -30 \text{ V}, V_{GS} = 0 \text{ V}$ $V_{DS} = -30 \text{ V}, V_{GS} = 0 \text{ V}, T_J = 55 \text{ °C}$			- 1	μA
Zero Gate Voltage Drain Current	IDSS				- 5	
On-State Drain Current <sup>a</sup>	I <sub>D(on)</sub>	$V_{DS} \ge$ - 10 V, $V_{GS}$ = - 10 V	- 20			A
	_	V <sub>GS</sub> = - 10 V, I <sub>D</sub> = - 6 A	0.056			Ω
Drain-Source On-State Resistance <sup>a</sup>	R <sub>DS(on)</sub>	V <sub>GS</sub> = - 4.5 V, I <sub>D</sub> = - 4 A				
Forward Transconductance <sup>a</sup>	9 <sub>fs</sub>	V <sub>DS</sub> = - 10 V, I <sub>D</sub> = - 6 A		28		S
Dynamic <sup>b</sup>						
Input Capacitance	C <sub>iss</sub>			1150		pF
Output Capacitance	C <sub>oss</sub>	V <sub>DS</sub> = - 15 V, V <sub>GS</sub> = 0 V, f = 1 MHz		205		
Reverse Transfer Capacitance	C <sub>rss</sub>			140		
Total Gate Charge		V <sub>DS</sub> = - 15 V, V <sub>GS</sub> = - 10 V, I <sub>D</sub> = - 6 A		27	43	3
	$Q_g$		19	25		
Gate-Source Charge	Q <sub>gs</sub>	V <sub>DS</sub> = - 15 V, V <sub>GS</sub> = - 4.5 V, I <sub>D</sub> = - 6 A		6		nC
Gate-Drain Charge	Q <sub>gd</sub>			12		
Gate Resistance	R <sub>g</sub>	f = 1 MHz	0.5	2.2	4.4	Ω
Turn-On Delay Time	t <sub>d(on)</sub>			13	25	
Rise Time	t <sub>r</sub>	$V_{DD}$ = - 15 V, $R_L$ = 1.5 $\Omega$		12	24	
Turn-Off DelayTime	t <sub>d(off)</sub>	$I_D \cong$ - 10 A, $V_{GEN}$ = - 10 V, $R_g$ = 1 $\Omega$		40	70	
Fall Time	t <sub>f</sub>			9	18	
Turn-On Delay Time	t <sub>d(on)</sub>			48	80	ns
Rise Time	t <sub>r</sub>	$V_{DD}$ = - 15 V, R <sub>L</sub> = 1.5 $\Omega$		92	160	
Turn-Off DelayTime	t <sub>d(off)</sub>	$I_D \cong$ - 6 A, $V_{GEN}$ = - 4.5 V, $R_g$ = 1 $\Omega$		34	60	
Fall Time	t <sub>f</sub>			19	35	
Drain-Source Body Diode Characteris	stics					<u> </u>
Continous Source-Drain Diode Current	۱ <sub>s</sub>	T <sub>C</sub> = 25 °C			- 4.1	
Pulse Diode Forward Current	I <sub>SM</sub>				- 60	A
Body Diode Voltage	V <sub>SD</sub>	I <sub>S</sub> = - 3 A, V <sub>GS</sub> = 0 V		- 0.75	- 1.2	V
Body Diode Reverse Recovery Time	t <sub>rr</sub>			27	45	ns
Body Diode Reverse Recovery Charge	Q <sub>rr</sub>			16	27	nC
Reverse Recovery Fall Time	t <sub>a</sub>	$I_F = -6 A, dI/dt = 100 A/\mu s, T_J = 25 °C$		12		
Reverse Recovery Rise Time	t <sub>b</sub>			15		ns

Notes:

a. Pulse test; pulse width  $\leq$  300  $\mu s,$  duty cycle  $\leq$  2 %.

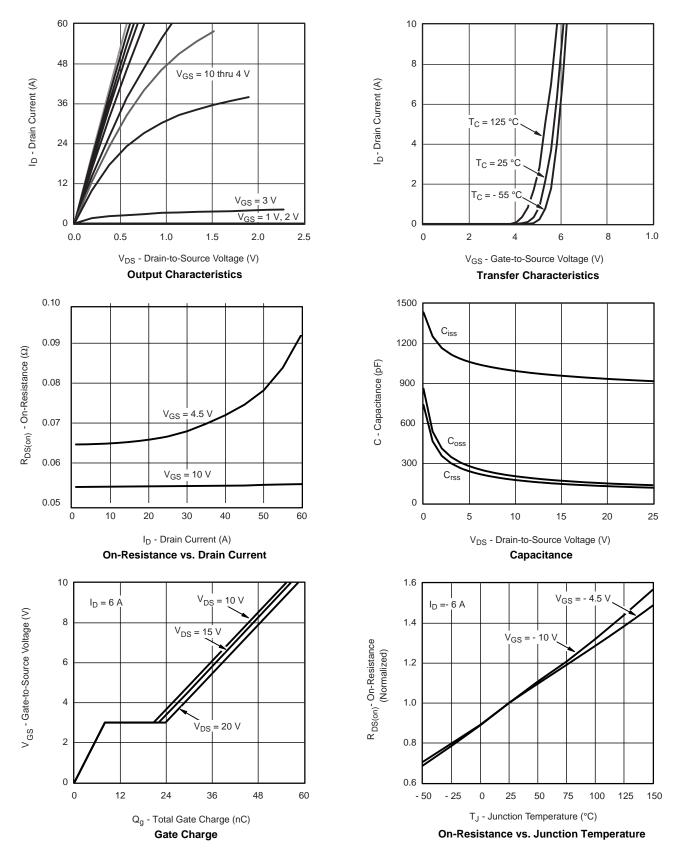
b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

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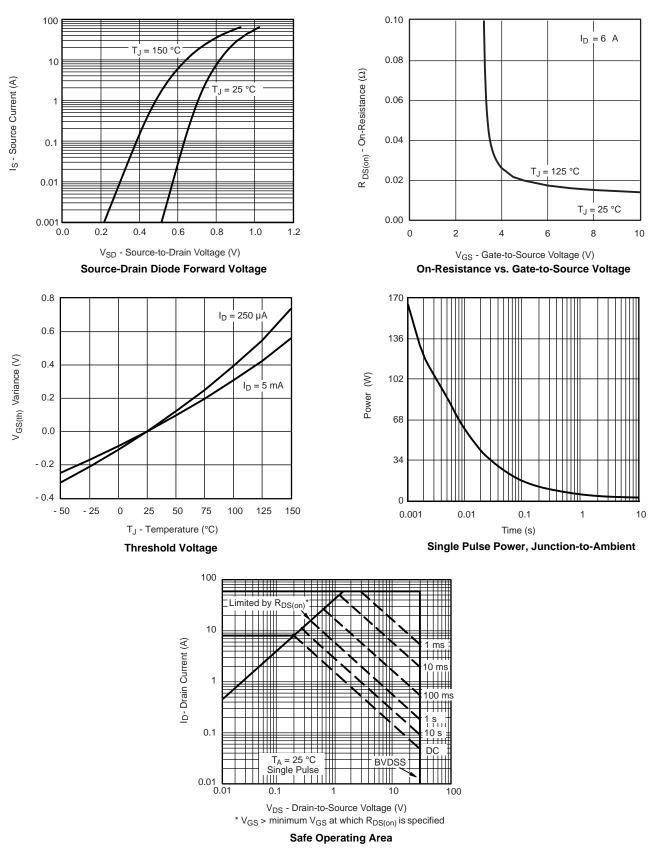


#### TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



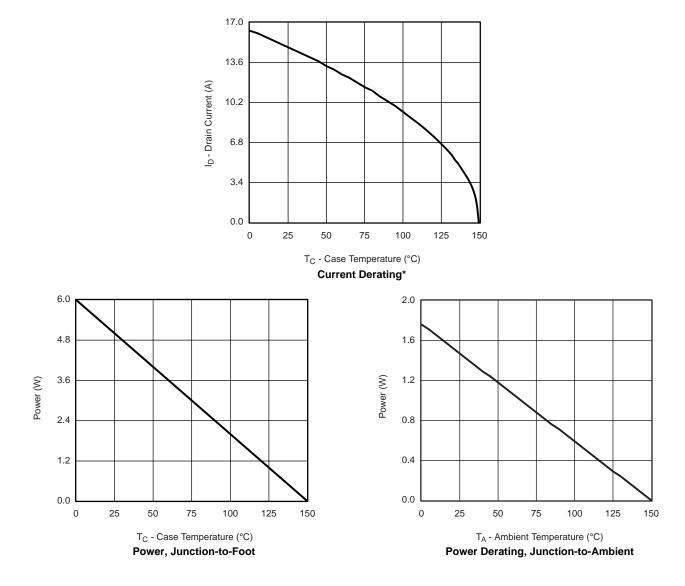


#### TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted





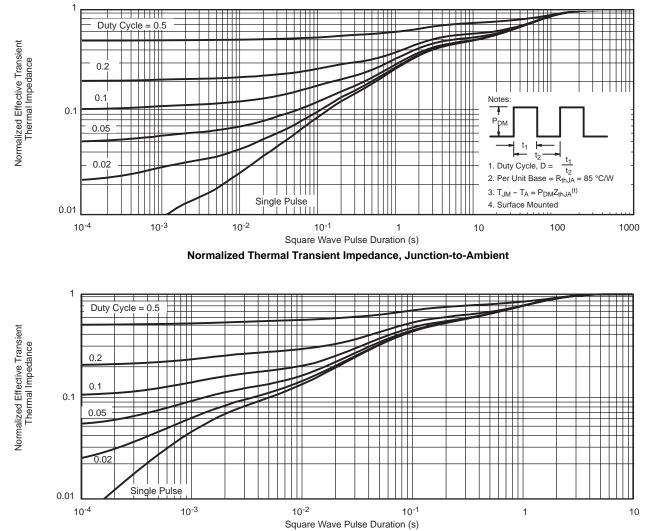
#### MOSFET TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



\* The power dissipation  $P_D$  is based on  $T_{J(max)}$  = 150 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.



#### TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

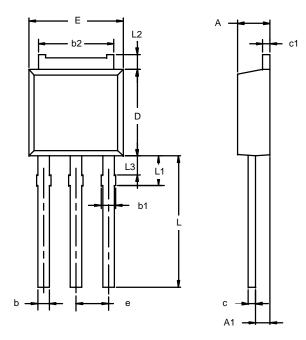


Normalized Thermal Transient Impedance, Junction-to-Foot

### AM20P03-60D-T1-PF-VB



**TO-251AA** 



	MILLIM	IETERS	INC	INCHES		
Dim	Min	Max	Min	Max		
Α	2.21	2.38	0.087	0.094		
A1	0.89	1.14	0.035	0.045		
b	0.71	0.89	0.028	0.035		
b1	0.76	1.14	0.030	0.045		
b2	5.23	5.43	0.206	0.214		
С	0.46	0.58	0.018	0.023		
c1	0.46	0.58	0.018	0.023		
D	5.97	6.22	0.235	0.245		
Е	6.48	6.73	0.255	0.265		
е	2.28 BSC		0.090	BSC		
L	3.89	9.53	0.153	0.375		
L1	1.91	2.28	0.075	0.090		
L2	0.89	1.27	0.035	0.050		
L3	1.15	1.52	0.045	0.060		

Note: Dimension L3 is for reference only.



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